## MMBD6100LT1G

## Monolithic Dual Switching Diode

## Features

- These Devices are $\mathrm{Pb}-$ Free, Halogen Free/BFR Free and are RoHS Compliant


## MAXIMUM RATINGS (EACH DIODE)

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Reverse Voltage | $\mathrm{V}_{\mathrm{R}}$ | 70 | Vdc |
| Forward Current | $\mathrm{I}_{\mathrm{F}}$ | 200 | mAdc |
| Peak Forward Surge Current | $\mathrm{I}_{\mathrm{FM}(\text { surge })}$ | 500 | mAdc |

## THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Total Device Dissipation, FR-5 Board | $\mathrm{P}_{\mathrm{D}}$ |  |  |
| (Note 1) |  | 225 | mW |
| $\mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |
| Derate above $25^{\circ} \mathrm{C}$ |  | 1.8 | $\mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Thermal Resistance, Junction-to-Ambient | $\mathrm{R}_{\theta \mathrm{JA}}$ | 556 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Total Device Dissipation Alumina Substrate | $\mathrm{P}_{\mathrm{D}}$ |  |  |
| (Note 2) |  | 300 | mW |
| $\mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 2.4 | $\mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Derate above $25^{\circ} \mathrm{C}$ |  | 417 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction-to-Ambient | $\mathrm{R}_{\theta J \mathrm{JA}}$ | 4.4 |  |
| Junction and Storage Temperature Range | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $\mathrm{FR}-5=1.0 \times 0.75 \times 0.062 \mathrm{in}$.
2. Alumina $=0.4 \times 0.3 \times 0.024 \mathrm{in} .99 .5 \%$ alumina.

ELECTRICAL CHARACTERISTICS $\left(T_{A}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |

OFF CHARACTERISTICS

| Reverse Breakdown Voltage $\left.\mathrm{l}_{(\mathrm{BR})}=100 \mu \mathrm{Adc}\right)$ | $\mathrm{V}_{\text {(BR) }}$ | 70 | - | Vdc |
| :---: | :---: | :---: | :---: | :---: |
| Reverse Voltage Leakage Current ( $\mathrm{V}_{\mathrm{R}}=50 \mathrm{Vdc}$ ) (For each individual diode while the second diode is unbiased) | $\mathrm{I}_{\mathrm{R}}$ | - | 0.1 | $\mu \mathrm{Adc}$ |
| Forward Voltage ( $\mathrm{I}_{\mathrm{F}}=1.0 \mathrm{mAdc}$ ) ( $\mathrm{I}_{\mathrm{F}}=100 \mathrm{mAdc}$ ) | $V_{F}$ | $\begin{gathered} 0.55 \\ 0.8 \end{gathered}$ | $\begin{aligned} & 0.7 \\ & 1.1 \end{aligned}$ | Vdc |
| Reverse Recovery Time $\left(I_{F}=I_{R}=10 \mathrm{mAdc}, \mathrm{I}_{\mathrm{R}(\mathrm{REC})}=1.0 \mathrm{mAdc}\right)$ (Figure 1) | $\mathrm{t}_{\mathrm{rr}}$ | - | 4.0 | ns |
| Capacitance $\left(V_{R}=0 V\right)$ | C | - | 2.5 | pF |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ON Semiconductor ${ }^{\circledR}$
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MARKING DIAGRAM


5B = Specific Device Code
M = Date Code*

- = Pb-Free Package
(Note: Microdot may be in either location)
*Date Code orientation and/or overbar may vary depending upon manufacturing location.


## ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| MMBD6100LT1G | SOT-23 <br> (Pb-Free) | 3000/Tape \& Reel |
| MMBD6100LT3G | SOT-23 <br> (Pb-Free) | 10,000/Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.


Notes: 1. A $2.0 \mathrm{k} \Omega$ variable resistor adjusted for a Forward Current $\left(\mathrm{I}_{\mathrm{F}}\right)$ of 10 mA .
2. Input pulse is adjusted so $\mathrm{I}_{\mathrm{R} \text { (peak) }}$ is equal to 10 mA .
3. $\mathrm{t}_{\mathrm{p}}$ " $\mathrm{t}_{\mathrm{rr}}$
Figure 1. Recovery Time Equivalent Test Circuit

CURVES APPLICABLE TO EACH CATHODE


Figure 2. Forward Voltage


Figure 3. Leakage Current


Figure 4. Capacitance

## MMBD6100LT1G

## PACKAGE DIMENSIONS

SOT-23 (TO-236)
CASE 318-08
ISSUE AR


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH PROTRUSIONS, OR GATE BURRS.

| DIM | MILLIMETERS |  |  | INCHES |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | NOM | MAX | MIN | NOM | MAX |
|  | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| c | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| L | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| T | $0^{\circ}$ | --- | $10^{\circ}$ | $0^{\circ}$ | --- | $10^{\circ}$ |

STYLE 9:
PIN 1. ANODE
2. ANODE
3. CATHODE

HODE

RECOMMENDED SOLDERING FOOTPRINT*

*For additional information on our $\mathrm{Pb}-F r e e$ strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

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